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Details

Product Status	Not For New Designs
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	CANbus, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM
Number of I/O	21
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc68908gz8vfje

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NP

General Description



1. Ports are software configurable with pullup device if input port.

2. Higher current drive port pins

3. Pin contains integrated pullup device

Figure 1-1. MCU Block Diagram



1.5.5 CGM Power Supply Pins (V_{DDA} and V_{SSA})

 V_{DDA} and V_{SSA} are the power supply pins for the analog portion of the clock generator module (CGM). Decoupling of these pins should be as per the digital supply. See Chapter 4 Clock Generator Module (CGM).

1.5.6 External Filter Capacitor Pin (V_{CGMXFC})

CGMXFC is an external filter capacitor connection for the CGM. See Chapter 4 Clock Generator Module (CGM).

1.5.7 ADC Power Supply/Reference Pins (V_{DDAD}/V_{REFH} and V_{SSAD}/V_{REFL})

 V_{DDAD} and V_{SSAD} are the power supply pins to the analog-to-digital converter (ADC). V_{REFH} and V_{REFL} are the reference voltage pins for the ADC. V_{REFH} is the high reference supply for the ADC, and by default the V_{DDAD}/V_{REFH} pin should be externally filtered and connected to the same voltage potential as V_{DD} . V_{REFL} is the low reference supply for the ADC, and by default the V_{SSAD}/V_{REFL} pin should be connected to the same voltage potential as V_{SS} . See Chapter 3 Analog-to-Digital Converter (ADC).

1.5.8 Port A Input/Output (I/O) Pins (PTA7/KBD7–PTA0/KBD0)

PTA7–PTA0 are general-purpose, bidirectional I/O port pins. Any or all of the port A pins can be programmed to serve as keyboard interrupt pins. PTA7–PTA4 are only available on the 48-pin LQFP package. See Chapter 13 Input/Output (I/O) Ports and Chapter 9 Keyboard Interrupt Module (KBI).

These port pins also have selectable pullups when configured for input mode. The pullups are disengaged when configured for output mode. The pullups are selectable on an individual port bit basis.

1.5.9 Port B I/O Pins (PTB7/AD7–PTB0/AD0)

PTB7–PTB0 are general-purpose, bidirectional I/O port pins that can also be used for analog-to-digital converter (ADC) inputs. PTB7–PTB4 are only available on the 48-pin LQFP package. See Chapter 13 Input/Output (I/O) Ports and Chapter 3 Analog-to-Digital Converter (ADC).

1.5.10 Port C I/O Pins (PTC6–PTC0/CAN_{TX})

PTC6 and PTC5 are general-purpose, bidirectional I/O port pins. PTC4–PTC0 are general-purpose, bidirectional I/O port pins that contain higher current sink/source capability. PTC6–PTC2 are only available on the 48-pin LQFP package. See Chapter 13 Input/Output (I/O) Ports and Chapter 12 MSCAN08 Controller (MSCAN08).

PTC1 and PTC0 can be programmed to be MSCAN08 pins.

These port pins also have selectable pullups when configured for input mode. The pullups are disengaged when configured for output mode. The pullups are selectable on an individual port bit basis.

1.5.11 Port D I/O Pins (PTD7/T2CH1-PTD0/SS)

PTD7–PTD0 are special-function, bidirectional I/O port pins. PTD3–PTD0 can be programmed to be serial peripheral interface (SPI) pins, while PTD7–PTD4 can be individually programmed to be timer interface module (TIM1 and TIM2) pins. PTD7 is only available on the 48-pin LQFP package. See Chapter 19 Timer Interface Module (TIM), Chapter 17 Serial Peripheral Interface (SPI) Module, and Chapter 13 Input/Output (I/O) Ports.



Input/Output (I/O) Section

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0	
	Timer 2 Channel 0 Status and	Read:	CH0F	CH0IE	MS0B	MS0A	ELS0B	ELS0A	TOV0	CHOMAX	
\$0030 Control Register (T2SC	Control Register (T2SC0)	Write:	0								
	See page 267.	Reset:	0	0	0	0	0	0	0	0	
\$0031	Timer 2 Channel 0 \$0031 Register High (T2CH0H)	Read: Write:	Bit 15	14	13	12	11	10	9	Bit 8	
	See page 270.	Reset:				Indetermina	te after reset				
\$0032	Timer 2 Channel 0 Register Low (T2CH0L)	Read: Write:	Bit 7	6	5	4	3	2	1	Bit 0	
	See page 270.	Reset:		Indeterminate after reset							
	Timer 2 Channel 1 Status and	Read:	CH1F		0	MOTA			TOVA	OUTMAX	
\$0033	Control Register (T2SC1)	Write:	0	CHIE		- MS1A	ELSIB	ELSTA	1001	CHIMAX	
	See page 267.	Reset:	0	0	0	0	0	0	0	0	
\$0034	Timer 2 Channel 1 Register High (T2CH1H)	Read: Write:	Bit 15	14	13	12	11	10	9	Bit 8	
	See page 270.	Reset:				Indetermina	te after reset				
\$0035	Timer 2 Channel 1 Register Low (T2CH1L)	Read: Write:	Bit 7	6	5	4	3	2	1	Bit 0	
	See page 270.	Reset:				Indetermina	te after reset				
\$0036	PLL Control Register (PCTL)	Read: Write:	PLLIE	PLLF	PLLON	BCS	R	R	VPR1	VPR0	
See page 6	See page 69.	Reset:	0	0	1	0	0	0	0	0	
DLL Danshuidh Oaster	DI L. Dondwidth Control	Read:		LOCK		0	0	0	0		
\$0037	Register (PBWC)	Write:	AUTO		ACQ					R	
See page 71	Reset:	0	0	0	0	0	0	0	0		
	DLL Multiplier Select High	Read:	0	0	0	0					
\$0038	Register (PMSH)	Write:					MUL11	MUL10	MUL9	MUL8	
	See page 72.	Reset:	0	0	0	0	0	0	0	0	
\$0039	PLL Multiplier Select Low Register (PMSL)	Read: Write:	MUL7	MUL6	MUL5	MUL4	MUL3	MUL2	MUL1	MULO	
	See page 73.	Reset:	0	0	0	0	U	U	U	U	
* ****	PLL VCO Select Range	Read:	VRS7	VRS6	VRS5	VRS4	VRS3	VRS2	VRS1	VRS0	
\$003A	Register (PMRS) See page 73	Write:									
	oce page 70.	Reset:	0	1	0	0	0	0	0	0	
		Read:	0	0	0	0	R	R	R	R	
\$003B	Reserved	Write:			_	_					
		Reset:	0	0	0	0	0	0	0	1	
				= Unimplem	nented	R = Reserve	d	U = Unaffect	ted		



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Clock Generator Module (CGM)

NOTE

Verify that the value of the PMRS register is appropriate for the given reference and VCO clock frequencies before enabling the PLL. See 4.3.6 Programming the PLL for detailed instructions on selecting the proper value for these control bits.

VRS7–VRS0 — VCO Range Select Bits

These read/write bits control the hardware center-of-range linear multiplier L which, in conjunction with E (See 4.3.3 PLL Circuits, 4.3.6 Programming the PLL, and 4.5.1 PLL Control Register.), controls the hardware center-of-range frequency, f_{VRS} . VRS7–VRS0 cannot be written when the PLLON bit in the PCTL is set. (See 4.3.7 Special Programming Exceptions.) A value of \$00 in the VCO range select register disables the PLL and clears the BCS bit in the PLL control register (PCTL). (See 4.3.8 Base Clock Selector Circuit and 4.3.7 Special Programming Exceptions.). Reset initializes the register to \$40 for a default range multiply value of 64.

NOTE

The VCO range select bits have built-in protection such that they cannot be written when the PLL is on (PLLON = 1) and such that the VCO clock cannot be selected as the source of the base clock (BCS = 1) if the VCO range select bits are all clear.

The PLL VCO range select register must be programmed correctly. Incorrect programming can result in failure of the PLL to achieve lock.

4.6 Interrupts

When the AUTO bit is set in the PLL bandwidth control register (PBWC), the PLL can generate a CPU interrupt request every time the LOCK bit changes state. The PLLIE bit in the PLL control register (PCTL) enables CPU interrupts from the PLL. PLLF, the interrupt flag in the PCTL, becomes set whether interrupts are enabled or not. When the AUTO bit is clear, CPU interrupts from the PLL are disabled and PLLF reads as logic 0.

Software should read the LOCK bit after a PLL interrupt request to see if the request was due to an entry into lock or an exit from lock. When the PLL enters lock, the VCO clock, CGMVCLK, divided by two can be selected as the CGMOUT source by setting BCS in the PCTL. When the PLL exits lock, the VCO clock frequency is corrupt, and appropriate precautions should be taken. If the application is not frequency sensitive, interrupts should be disabled to prevent PLL interrupt service routines from impeding software performance or from exceeding stack limitations.

NOTE

Software can select the CGMVCLK divided by two as the CGMOUT source even if the PLL is not locked (LOCK = 0). Therefore, software should make sure the PLL is locked before setting the BCS bit.



Configuration Register (CONFIG)



Note: LVI5OR3 bit is only reset via POR (power-on reset).

Figure 5-2. Configuration Register 1 (CONFIG1)

MSCANEN— MSCAN08 Enable Bit

Setting the MSCANEN enables the MSCAN08 module and allows the MSCAN08 to use the PTC0/PTC1 pins. See Chapter 12 MSCAN08 Controller (MSCAN08) for a more detailed description of the MSCAN08 operation.

1 = Enables MSCAN08 module

0 = Disables the MSCAN08 module

NOTE

The MSCANEN bit is cleared by a power-on reset (POR) only. Other resets will leave this bit unaffected.

TMCLKSEL— Timebase Clock Select Bit

TMCLKSEL enables an extra divide-by-128 prescaler in the timebase module. Setting this bit enables the extra prescaler and clearing this bit disables it. See Chapter 4 Clock Generator Module (CGM) for a more detailed description of the external clock operation.

1 = Enables extra divide-by-128 prescaler in timebase module

0 = Disables extra divide-by-128 prescaler in timebase module

OSCENINSTOP — Oscillator Enable In Stop Mode Bit

OSCENINSTOP, when set, will enable the oscillator to continue to generate clocks in stop mode. See Chapter 4 Clock Generator Module (CGM). This function is used to keep the timebase running while the reset of the MCU stops. See Chapter 18 Timebase Module (TBM). When clear, oscillator will cease to generate clocks while in stop mode. The default state for this option is clear, disabling the oscillator in stop mode.

1 = Oscillator enabled to operate during stop mode

0 = Oscillator disabled during stop mode (default)

ESCIBDSRC — SCI Baud Rate Clock Source Bit

ESCIBDSRC controls the clock source used for the serial communications interface (SCI). The setting of this bit affects the frequency at which the SCI operates. See Chapter 15 Enhanced Serial Communications Interface (ESCI) Module.

1 = Internal data bus clock used as clock source for SCI (default)

0 = External oscillator used as clock source for SCI

COPRS — COP Rate Select Bit

COPD selects the COP timeout period. Reset clears COPRS. See Chapter 6 Computer Operating Properly (COP) Module

1 = COP timeout period = $2^{13} - 2^4$ COPCLK cycles

0 = COP timeout period = $2^{18} - 2^4$ COPCLK cycles



10.6 Computer Operating Properly Module (COP)

10.6.1 Wait Mode

The COP remains active during wait mode. If COP is enabled, a reset will occur at COP timeout.

10.6.2 Stop Mode

Stop mode turns off the COPCLK input to the COP and clears the COP prescaler. Service the COP immediately before entering or after exiting stop mode to ensure a full COP timeout period after entering or exiting stop mode.

The STOP bit in the CONFIG1 register enables the STOP instruction. To prevent inadvertently turning off the COP with a STOP instruction, disable the STOP instruction by clearing the STOP bit.

10.7 External Interrupt Module (IRQ)

10.7.1 Wait Mode

The external interrupt (IRQ) module remains active in wait mode. Clearing the IMASK1 bit in the IRQ status and control register enables IRQ CPU interrupt requests to bring the MCU out of wait mode.

10.7.2 Stop Mode

The IRQ module remains active in stop mode. Clearing the IMASK1 bit in the IRQ status and control register enables IRQ CPU interrupt requests to bring the MCU out of stop mode.

10.8 Keyboard Interrupt Module (KBI)

10.8.1 Wait Mode

The keyboard interrupt (KBI) module remains active in wait mode. Clearing the IMASKK bit in the keyboard status and control register enables keyboard interrupt requests to bring the MCU out of wait mode.

10.8.2 Stop Mode

The keyboard module remains active in stop mode. Clearing the IMASKK bit in the keyboard status and control register enables keyboard interrupt requests to bring the MCU out of stop mode.



MSCAN08 Controller (MSCAN08)



Figure 12-8. Clocking Scheme

NOTE

If the system clock is generated from a PLL, it is recommended to select the crystal clock source rather than the system clock source due to jitter considerations, especially at faster CAN bus rates.

A programmable prescaler is used to generate out of the MSCAN08 clock the time quanta (Tq) clock. A time quantum is the atomic unit of time handled by the MSCAN08.

$$f_{Tq} = \frac{f_{MSCANCLK}}{Presc value}$$

A bit time is subdivided into three segments⁽¹⁾ (see Figure 12-9):

- SYNC_SEG: This segment has a fixed length of one time quantum. Signal edges are expected to happen within this section.
- Time segment 1: This segment includes the PROP_SEG and the PHASE_SEG1 of the CAN standard. It can be programmed by setting the parameter TSEG1 to consist of 4 to 16 time quanta.
- Time segment 2: This segment represents PHASE_SEG2 of the CAN standard. It can be programmed by setting the TSEG2 parameter to be 2 to 8 time quanta long.

Bit rate =
$$\frac{f_{Tq}}{No. of time quanta}$$

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^{1.} For further explanation of the underlying concepts please refer to ISO/DIS 11 519-1, Section 10.3.



T1CH1 and T1CH0 — Timer 1 Channel I/O Bits

The PTD7/T1CH1–PTD6/T1CH0 pins are the TIM1 input capture/output compare pins. The edge/level select bits, ELSxB and ELSxA, determine whether the PTD7/T1CH1–PTD6/T1CH0 pins are timer channel I/O pins or general-purpose I/O pins. See Chapter 19 Timer Interface Module (TIM).

SPSCK — SPI Serial Clock

The PTD3/SPSCK pin is the serial clock input of the SPI module. When the SPE bit is clear, the PTD3/SPSCK pin is available for general-purpose I/O.

MOSI — Master Out/Slave In

The PTD2/MOSI pin is the master out/slave in terminal of the SPI module. When the SPE bit is clear, the PTD2/MOSI pin is available for general-purpose I/O.

MISO — Master In/Slave Out

The PTD1/MISO pin is the master in/slave out terminal of the SPI module. When the SPI enable bit, SPE, is clear, the SPI module is disabled, and the PTD0/SS pin is available for general-purpose I/O.

Data direction register D (DDRD) does not affect the data direction of port D pins that are being used by the SPI module. However, the DDRD bits always determine whether reading port D returns the states of the latches or the states of the pins. See Table 13-5.

SS — Slave Select

The PTD0/SS pin is the slave select input of the SPI module. When the SPE bit is clear, or when the SPI master bit, SPMSTR, is set, the PTD0/SS pin is available for general-purpose I/O. When the SPI is enabled, the DDRB0 bit in data direction register B (DDRB) has no effect on the PTD0/SS pin.

13.6.2 Data Direction Register D

Data direction register D (DDRD) determines whether each port D pin is an input or an output. Writing a logic 1 to a DDRD bit enables the output buffer for the corresponding port D pin; a logic 0 disables the output buffer.





DDRD7–DDRD0 — Data Direction Register D Bits

These read/write bits control port D data direction. Reset clears DDRD7–DDRD0, configuring all port D pins as inputs.

1 = Corresponding port D pin configured as output

0 = Corresponding port D pin configured as input

NOTE

Avoid glitches on port D pins by writing to the port D data register before changing data direction register D bits from 0 to 1.

Figure 13-15 shows the port D I/O logic.



Input/Output (I/O) Ports



Figure 13-15. Port D I/O Circuit

When bit DDRDx is a logic 1, reading address \$0003 reads the PTDx data latch. When bit DDRDx is a logic 0, reading address \$0003 reads the voltage level on the pin. The data latch can always be written, regardless of the state of its data direction bit. Table 13-5 summarizes the operation of the port D pins.

PTDPUE	DDRD	PTD	I/O Pin	Accesses to DDRD	Access	ses to PTD
Bit	Bit	Bit	Mode	Read/Write	Read	Write
1	0	X ⁽¹⁾	Input, V _{DD} ⁽²⁾	DDRD7-DDRD0	Pin	PTD7–PTD0 ⁽³⁾
0	0	Х	Input, Hi-Z ⁽⁴⁾	DDRD7-DDRD0	Pin	PTD7–PTD0 ⁽³⁾
Х	1	Х	Output	DDRD7-DDRD0	PTD7–PTD0	PTD7–PTD0

Table 13-5. Port D Pin Functions

1. X = Don't care

2. I/O pin pulled up to V_{DD} by internal pullup device.

3. Writing affects data register, but does not affect input.

4. Hi-Z = High impedance

13.6.3 Port D Input Pullup Enable Register

The port D input pullup enable register (PTDPUE) contains a software configurable pullup device for each of the eight port D pins. Each bit is individually configurable and requires that the data direction register, DDRD, bit be configured as an input. Each pullup is automatically and dynamically disabled when a port bit's DDRD is configured for output mode.



Figure 13-16. Port D Input Pullup Enable Register (PTDPUE)

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ILIE — Idle Line Interrupt Enable Bit

This read/write bit enables the IDLE bit to generate ESCI receiver CPU interrupt requests. Reset clears the ILIE bit.

1 = IDLE enabled to generate CPU interrupt requests

0 = IDLE not enabled to generate CPU interrupt requests

TE — Transmitter Enable Bit

Setting this read/write bit begins the transmission by sending a preamble of 10 or 11 logic 1s from the transmit shift register to the TxD pin. If software clears the TE bit, the transmitter completes any transmission in progress before the TxD returns to the idle condition (logic 1). Clearing and then setting TE during a transmission queues an idle character to be sent after the character currently being transmitted. Reset clears the TE bit.

1 = Transmitter enabled

0 = Transmitter disabled

NOTE

Writing to the TE bit is not allowed when the enable ESCI bit (ENSCI) is clear. ENSCI is in ESCI control register 1.

RE — Receiver Enable Bit

Setting this read/write bit enables the receiver. Clearing the RE bit disables the receiver but does not affect receiver interrupt flag bits. Reset clears the RE bit.

1 = Receiver enabled

0 = Receiver disabled

NOTE

Writing to the RE bit is not allowed when the enable ESCI bit (ENSCI) is clear. ENSCI is in ESCI control register 1.

RWU — Receiver Wakeup Bit

This read/write bit puts the receiver in a standby state during which receiver interrupts are disabled. The WAKE bit in SCC1 determines whether an idle input or an address mark brings the receiver out of the standby state and clears the RWU bit. Reset clears the RWU bit.

1 = Standby state

0 = Normal operation

SBK — Send Break Bit

Setting and then clearing this read/write bit transmits a break character followed by a logic 1. The logic 1 after the break character guarantees recognition of a valid start bit. If SBK remains set, the transmitter continuously transmits break characters with no logic 1s between them. Reset clears the SBK bit.

1 = Transmit break characters

0 = No break characters being transmitted

NOTE

Do not toggle the SBK bit immediately after setting the SCTE bit. Toggling SBK before the preamble begins causes the ESCI to send a break character instead of a preamble.



Enhanced Serial Communications Interface (ESCI) Module

15.8.3 ESCI Control Register 3

ESCI control register 3 (SCC3):

- Stores the ninth ESCI data bit received and the ninth ESCI data bit to be transmitted.
- Enables these interrupts:
 - Receiver overrun
 - Noise error
 - Framing error
 - Parity error



Figure 15-12. ESCI Control Register 3 (SCC3)

R8 — Received Bit 8

When the ESCI is receiving 9-bit characters, R8 is the read-only ninth bit (bit 8) of the received character. R8 is received at the same time that the SCDR receives the other 8 bits.

When the ESCI is receiving 8-bit characters, R8 is a copy of the eighth bit (bit 7). Reset has no effect on the R8 bit.

T8 — Transmitted Bit 8

When the ESCI is transmitting 9-bit characters, T8 is the read/write ninth bit (bit 8) of the transmitted character. T8 is loaded into the transmit shift register at the same time that the SCDR is loaded into the transmit shift register. Reset clears the T8 bit.

ORIE — Receiver Overrun Interrupt Enable Bit

This read/write bit enables ESCI error CPU interrupt requests generated by the receiver overrun bit, OR. Reset clears ORIE.

1 = ESCI error CPU interrupt requests from OR bit enabled

0 = ESCI error CPU interrupt requests from OR bit disabled

NEIE — Receiver Noise Error Interrupt Enable Bit

This read/write bit enables ESCI error CPU interrupt requests generated by the noise error bit, NE. Reset clears NEIE.

1 = ESCI error CPU interrupt requests from NE bit enabled

0 = ESCI error CPU interrupt requests from NE bit disabled

FEIE — Receiver Framing Error Interrupt Enable Bit

This read/write bit enables ESCI error CPU interrupt requests generated by the framing error bit, FE. Reset clears FEIE.

1 = ESCI error CPU interrupt requests from FE bit enabled

0 = ESCI error CPU interrupt requests from FE bit disabled

PEIE — Receiver Parity Error Interrupt Enable Bit

This read/write bit enables ESCI receiver CPU interrupt requests generated by the parity error bit, PE. Reset clears PEIE.

1 = ESCI error CPU interrupt requests from PE bit enabled

0 = ESCI error CPU interrupt requests from PE bit disabled

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Enhanced Serial Communications Interface (ESCI) Module

15.8.6 ESCI Data Register

The ESCI data register (SCDR) is the buffer between the internal data bus and the receive and transmit shift registers. Reset has no effect on data in the ESCI data register.

Address:	\$0018							
	Bit 7	6	5	4	3	2	1	Bit 0
Read:	R7	R6	R5	R4	R3	R2	R1	R0
Write:	T7	T6	T5	T4	Т3	T2	T1	Т0
Reset:				Unaffecte	d bv reset			

Figure 15-16. ESCI Data Register (SCDR)

R7/T7:R0/T0 — Receive/Transmit Data Bits

Reading address \$0018 accesses the read-only received data bits, R7:R0. Writing to address \$0018 writes the data to be transmitted, T7:T0. Reset has no effect on the ESCI data register.

NOTE

Do not use read-modify-write instructions on the ESCI data register.

15.8.7 ESCI Baud Rate Register

The ESCI baud rate register (SCBR) together with the ESCI prescaler register selects the baud rate for both the receiver and the transmitter.

NOTE There are two prescalers available to adjust the baud rate. One in the ESCI baud rate register and one in the ESCI prescaler register.



Figure 15-17. ESCI Baud Rate Register (SCBR)

LINT — LIN Transmit Enable

This read/write bit selects the enhanced ESCI features for the local interconnect network (LIN) protocol as shown in Table 15-6. Reset clears LINT.

LINR — LIN Receiver Bits

This read/write bit selects the enhanced ESCI features for the local interconnect network (LIN) protocol as shown in Table 15-6. Reset clears LINR.



Enhanced Serial Communications Interface (ESCI) Module

15.8.8 ESCI Prescaler Register

The ESCI prescaler register (SCPSC) together with the ESCI baud rate register selects the baud rate for both the receiver and the transmitter.

NOTE

There are two prescalers available to adjust the baud rate. One in the ESCI baud rate register and one in the ESCI prescaler register.



Figure 15-18. ESCI Prescaler Register (SCPSC)

PDS2–PDS0 — Prescaler Divisor Select Bits

These read/write bits select the prescaler divisor as shown in Table 15-9. Reset clears PDS2–PDS0.

NOTE

The setting of '000' will bypass this prescaler. It is not recommended to bypass the prescaler while ENSCI is set, because the switching is not glitch free.

Table 15-9.	ESCI	Prescaler	Division	Ratio
-------------	------	-----------	----------	-------

PS[2:1:0]	Prescaler Divisor (PD)
0 0 0	Bypass this prescaler
001	2
0 1 0	3
0 1 1	4
100	5
101	6
1 1 0	7
1 1 1	8

PSSB4–PSSB0 — Clock Insertion Select Bits

These read/write bits select the number of clocks inserted in each 32 output cycle frame to achieve more timing resolution on the **average** prescaler frequency as shown in Table 15-10. Reset clears PSSB4–PSSB0.

Use the following formula to calculate the ESCI baud rate:

Baud rate = $\frac{\text{Frequency of the SCI clock source}}{64 \text{ x BPD x BD x (PD + PDFA)}}$

where:

Frequency of the SCI clock source = f_{Bus} or CGMXCLK (selected by

ESCIBDSRC in the CONFIG2 register)

BPD = Baud rate register prescaler divisor

BD = Baud rate divisor

PD = Prescaler divisor

PDFA = Prescaler divisor fine adjust



Exception Control



Figure 16-10. Interrupt Processing



17.5.3 Transmission Format When CPHA = 1

Figure 17-7 shows an SPI transmission in which CPHA is logic 1. The figure should not be used as a replacement for data sheet parametric information. Two waveforms are shown for SPSCK: one for CPOL = 0 and another for CPOL = 1. The diagram may be interpreted as a master or slave timing diagram since the serial clock (SPSCK), master in/slave out (MISO), and master out/slave in (MOSI) pins are directly connected between the master and the slave. The MISO signal is the output from the slave, and the MOSI signal is the output from the master. The \overline{SS} line is the slave select input to the slave. The slave SPI drives its MISO output only when its slave select input (\overline{SS}) is at logic 0, so that only the selected slave drives to the master. The \overline{SS} pin of the master is not shown but is assumed to be inactive. The \overline{SS} pin of the master must be high or must be reconfigured as general-purpose I/O not affecting the SPI. (See 17.7.2 Mode Fault Error.) When CPHA = 1, the master begins driving its MOSI pin on the first SPSCK edge. Therefore, the slave uses the first SPSCK edge as a start transmission signal. The \overline{SS} pin can remain low between transmissions. This format may be preferable in systems having only one master and only one slave driving the MISO data line.



When CPHA = 1 for a slave, the first edge of the SPSCK indicates the beginning of the transmission. This causes the SPI to leave its idle state and begin driving the MISO pin with the MSB of its data. Once the transmission begins, no new data is allowed into the shift register from the transmit data register. Therefore, the SPI data register of the slave must be loaded with transmit data before the first edge of SPSCK. Any data written after the first edge is stored in the transmit data register and transferred to the shift register after the current transmission.

17.5.4 Transmission Initiation Latency

When the SPI is configured as a master (SPMSTR = 1), writing to the SPDR starts a transmission. CPHA has no effect on the delay to the start of the transmission, but it does affect the initial state of the SPSCK signal. When CPHA = 0, the SPSCK signal remains inactive for the first half of the first SPSCK cycle. When CPHA = 1, the first SPSCK cycle begins with an edge on the SPSCK line from its inactive to its active level. The SPI clock rate (selected by SPR1:SPR0) affects the delay from the write to SPDR and the start of the SPI transmission. (See Figure 17-8.)



In this case, an overflow can be missed easily. Since no more SPRF interrupts can be generated until this OVRF is serviced, it is not obvious that bytes are being lost as more transmissions are completed. To prevent this, either enable the OVRF interrupt or do another read of the SPSCR following the read of the SPDR. This ensures that the OVRF was not set before the SPRF was cleared and that future transmissions can set the SPRF bit. Figure 17-11 illustrates this process. Generally, to avoid this second SPSCR read, enable the OVRF to the CPU by setting the ERRIE bit.

17.7.2 Mode Fault Error

Setting the SPMSTR bit selects master mode and configures the SPSCK and MOSI pins as outputs and the MISO pin as an input. Clearing SPMSTR selects slave mode and configures the SPSCK and MOSI pins as inputs and the MISO pin as an output. The mode fault bit, MODF, becomes set any time the state of the slave select pin, SS, is inconsistent with the mode selected by SPMSTR.

To prevent SPI pin contention and damage to the MCU, a mode fault error occurs if:

- The SS pin of a slave SPI goes high during a transmission
- The SS pin of a master SPI goes low at any time

For the MODF flag to be set, the mode fault error enable bit (MODFEN) must be set. Clearing the MODFEN bit does not clear the MODF flag but does prevent MODF from being set again after MODF is cleared.



Figure 17-11. Clearing SPRF When OVRF Interrupt Is Not Enabled



Timer Interface Module (TIM)

Use the following methods to synchronize unbuffered changes in the PWM pulse width on channel x:

- When changing to a shorter pulse width, enable channel x output compare interrupts and write the new value in the output compare interrupt routine. The output compare interrupt occurs at the end of the current pulse. The interrupt routine has until the end of the PWM period to write the new value.
- When changing to a longer pulse width, enable TIM overflow interrupts and write the new value in the TIM overflow interrupt routine. The TIM overflow interrupt occurs at the end of the current PWM period. Writing a larger value in an output compare interrupt routine (at the end of the current pulse) could cause two output compares to occur in the same PWM period.

NOTE

In PWM signal generation, do not program the PWM channel to toggle on output compare. Toggling on output compare prevents reliable 0% duty cycle generation and removes the ability of the channel to self-correct in the event of software error or noise. Toggling on output compare also can cause incorrect PWM signal generation when changing the PWM pulse width to a new, much larger value.

19.4.4.2 Buffered PWM Signal Generation

Channels 0 and 1 can be linked to form a buffered PWM channel whose output appears on the TCH0 pin. The TIM channel registers of the linked pair alternately control the pulse width of the output.

Setting the MS0B bit in TIM channel 0 status and control register (TSC0) links channel 0 and channel 1. The TIM channel 0 registers initially control the pulse width on the TCH0 pin. Writing to the TIM channel 1 registers enables the TIM channel 1 registers to synchronously control the pulse width at the beginning of the next PWM period. At each subsequent overflow, the TIM channel registers (0 or 1) that control the pulse width are the ones written to last. TSC0 controls and monitors the buffered PWM function, and TIM channel 1 status and control register (TSC1) is unused. While the MS0B bit is set, the channel 1 pin, TCH1, is available as a general-purpose I/O pin.

NOTE

In buffered PWM signal generation, do not write new pulse width values to the currently active channel registers. User software should track the currently active channel to prevent writing a new value to the active channel. Writing to the active channel registers is the same as generating unbuffered PWM signals.

19.4.4.3 PWM Initialization

To ensure correct operation when generating unbuffered or buffered PWM signals, use the following initialization procedure:

- 1. In the TIM status and control register (TSC):
 - a. Stop the TIM counter by setting the TIM stop bit, TSTOP.
 - b. Reset the TIM counter and prescaler by setting the TIM reset bit, TRST.
- 2. In the TIM counter modulo registers (TMODH:TMODL), write the value for the required PWM period.
- 3. In the TIM channel x registers (TCHxH:TCHxL), write the value for the required pulse width.



Development Support

Enter monitor mode with pin configuration shown in Table 20-1 by pulling \overline{RST} low and then high. The rising edge of \overline{RST} latches monitor mode. Once monitor mode is latched, the values on the specified pins can change.

Once out of reset, the MCU waits for the host to send eight security bytes (see 20.3.2 Security). After the security bytes, the MCU sends a break signal (10 consecutive logic 0s) to the host, indicating that it is ready to receive a command.

20.3.1.1 Normal Monitor Mode

If V_{TST} is applied to \overline{IRQ} and PTB4 is low upon monitor mode entry, the bus frequency is a divide-by-two of the input clock. If PTB4 is high with V_{TST} applied to \overline{IRQ} upon monitor mode entry, the bus frequency will be a divide-by-four of the input clock. Holding the PTB4 pin low when entering monitor mode causes a bypass of a divide-by-two stage at the oscillator *only if* V_{TST} *is applied to* \overline{IRQ} . In this event, the CGMOUT frequency is equal to the CGMXCLK frequency, and the OSC1 input directly generates internal bus clocks. In this case, the OSC1 signal must have a 50% duty cycle at maximum bus frequency.

When monitor mode was entered with V_{TST} on \overline{IRQ} , the computer operating properly (COP) is disabled as long as V_{TST} is applied to either \overline{IRQ} or \overline{RST} .

This condition states that as long as V_{TST} is maintained on the \overline{IRQ} pin after entering monitor mode, or if V_{TST} is applied to \overline{RST} after the initial reset to get into monitor mode (when V_{TST} was applied to \overline{IRQ}), then the COP will be disabled. In the latter situation, after V_{TST} is applied to the \overline{RST} pin, V_{TST} can be removed from the \overline{IRQ} pin in the interest of freeing the \overline{IRQ} for normal functionality in monitor mode.

20.3.1.2 Forced Monitor Mode

If entering monitor mode without high voltage on \overline{IRQ} , then all port B pin requirements and conditions, including the PTB4 frequency divisor selection, are not in effect. This is to reduce circuit requirements when performing in-circuit programming.

NOTE

If the reset vector is blank and monitor mode is entered, the chip will see an additional reset cycle after the initial power-on reset (POR). Once the reset vector has been programmed, the traditional method of applying a voltage, V_{TST} , to \overline{IRQ} must be used to enter monitor mode.

An external oscillator of 8 MHz is required for a baud rate of 7200, as the internal bus frequency is automatically set to the external frequency divided by four.

When the forced monitor mode is entered the COP is always disabled regardless of the state of \overline{IRQ} or RST.

20.3.1.3 Monitor Vectors

In monitor mode, the MCU uses different vectors for reset, SWI (software interrupt), and break interrupt than those for user mode. The alternate vectors are in the \$FE page instead of the \$FF page and allow code execution from the internal monitor firmware instead of user code.

Table 20-2 summarizes the differences between user mode and monitor mode.



Electrical Specifications

Characteristic ⁽¹⁾	Symbol	Min	Тур ⁽²⁾	Мах	Unit
Monitor mode entry voltage	V _{TST}	V _{DD} + 2.5		V _{DD} + 4.0	V
Low-voltage inhibit, trip falling voltage	V _{TRIPF}	2.35	2.6	2.7	V
Low-voltage inhibit, trip rising voltage	V _{TRIPR}	2.4	2.66	2.8	V
Low-voltage inhibit reset/recover hysteresis (V _{TRIPF} + V _{HYS} = V _{TRIPR})	V _{HYS}	_	100	_	mV
POR rearm voltage ⁽¹²⁾	V _{POR}	0		100	mV
POR reset voltage ⁽¹³⁾	V _{PORRST}	0	700	800	mV
POR rise time ramp rate ⁽¹⁴⁾	R _{POR}	0.035	_	_	V/ms

1. V_{DD} = 3.3 Vdc ± 10%, V_{SS} = 0 Vdc, T_A = T_A (min) to T_A (max), unless otherwise noted

2. Typical values reflect average measurements at midpoint of voltage range, 25°C only.

 Run (operating) I_{DD} measured using external square wave clock source (f_{OSC} = 16 MHz). All inputs 0.2 V from rail. No dc loads. Less than 100 pF on all outputs. C_L = 20 pF on OSC2. All ports configured as inputs. OSC2 capacitance linearly affects run I_{DD}. Measured with all modules enabled.

4. Wait I_{DD} measured using external square wave clock source ($f_{OSC} = 16$ MHz). All inputs 0.2 V from rail. No dc loads. Less than 100 pF on all outputs. C_L = 20 pF on OSC2. All ports configured as inputs. OSC2 capacitance linearly affects wait I_{DD}. Measured with CGM and LVI enabled.

Stop I_{DD} is measured with OSC1 = V_{SS}. All inputs 0.2 V from rail. No dc loads. Less than 100 pF on all outputs. All ports configured as inputs. Typical values at midpoint of voltage range, 25°C only.

6. Stop I_{DD} with TBM enabled is measured using an external square wave clock source (f_{OSC} = 4 MHz). All inputs 0.2 V from rail. No dc loads. Less than 100 pF on all outputs. All inputs configured as inputs.

7. This parameter is characterized and not tested on each device.

8. All functional non-supply pins are internally clamped to V_{SS} and V_{DD} .

9. Input must be current limited to the value specified. To determine the value of the required current-limiting resistor, calculate resistance values for positive and negative clamp voltages, then use the larger of the two values.

10. Power supply must maintain regulation within operating V_{DD} range during instantaneous and operating maximum current conditions. If positive injection current (V_{in} > V_{DD}) is greater than I_{DD}, the injection current may flow out of V_{DD} and could result in external power supply going out of regulation. Ensure external V_{DD} load will shunt current greater than maximum injection current. This will be the greatest risk when the MCU is not consuming power. Examples are: if no system clock is present, or if clock rate is very low (which would reduce overall power consumption).

11. Pullups and pulldowns are disabled.

12. Maximum is highest voltage that POR is guaranteed.

13. Maximum is highest voltage that POR is possible.

14. If minimum V_{DD} is not reached before the internal POR reset is released, RST must be driven low ext ernally until minimum V_{DD} is reached.